<u>MOSFET</u> – POWERTRENCH[®] N-Channel

80 V, 220 A, 3.0 mΩ

FDBL86366-F085

Features

- Typical $R_{DS(on)} = 2.4 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- Typical $Q_{g(tot)} = 86 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS Capability
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12 V Systems

MOSFET MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain-to-Source Voltage	80	V
V _{GS}	Gate-to-Source Voltage	±20	V
Ι _D	Drain Current – Continuous (V_{GS} = 10), T _C = 25°C (Note 1)	220	A
	Pulsed Drain Current, $T_C = 25^{\circ}C$	See Figure 4	
E _{AS}	Single Pulse Avalanche Energy (Note 2)	205	mJ
PD	Power Dissipation	300	W
	Derate Above 25°C	2.0	W/°C
T _J , T _{STG}	Operating and Storage Temperature	–55 to +175	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.5	°C/W
$R_{ hetaJA}$	Maximum Thermal Resistance, Junction to Ambient (Note 3)	43	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

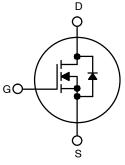
1. Current is limited by silicon.

- 2. Starting $T_J = 25^{\circ}$ C, $\dot{L} = 0.1$ mH, $I_{AS} = 64$ A, $V_{DD} = 80$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.



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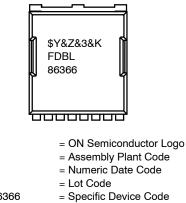


N-Channel



H-PSOF8L CASE 100CU

MARKING DIAGRAM



FDBL86366

\$Y

&Z

&З

&K

= Specific Device

ORDERING INFORMATION

Device	Top Mark	Package	Shipping [†]
0BL86366 085	FDBL86366	H-PSOF8L	2000 Units/ Tape&Reel

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit	
OFF CHARACTERISTICS								
BV _{DSS}	Drain-to-Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$		80	_	-	V	
I _{DSS}	Drain-to-Source Leakage Current	V _{DS} = 80 V, V _{GS} = 0 V	$T_J = 25^{\circ}C$	-	-	1	μA	
			T _J = 175°C (Note 4)	-	-	1	mA	
I _{GSS}	Gate-to-Source Leakage Current	V _{GS} = ±20 V		_	_	±100	nA	
ON CHARACT	ON CHARACTERISTICS							

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS}=V_{DS},\ I_{D}=250\ \mu A$		2.0	3.0	4.0	V
R _{DS(on)}	Drain to Source on Resistance	I _D = 80 A,	$T_J = 25^{\circ}C$	-	2.4	3.0	mΩ
		V _{GS} = 10 V	T _J = 175°C (Note 4)	-	4.9	6.1	mΩ

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 40 V, V_{GS}	V_{DS} = 40 V, V_{GS} = 0 V, f = 1 MHz		6320	-	pF
C _{oss}	Output Capacitance				1030	1	pF
C _{rss}	Reverse Transfer Capacitance			-	32	-	pF
R _g	Gate Resistance	f = 1 MHz	f = 1 MHz		2.1	1	Ω
Q _{g(ToT)}	Total Gate Charge at 10 V	V_{GS} = 0 to 10 V		-	86	112	nC
Q _{g(th)}	Threshold Gate Charge	V_{GS} = 0 to 2 V	I _D = 80 A	-	12	18	nC
Q _{gs}	Gate-to-Source Gate Charge	V _{DD} = 64 V, I _D =	V _{DD} = 64 V, I _D = 80 A		30	-	nC
Q _{gd}	Gate-to-Drain "Miller" Charge			_	18	-	nC

SWITCHING CHARACTERISTICS

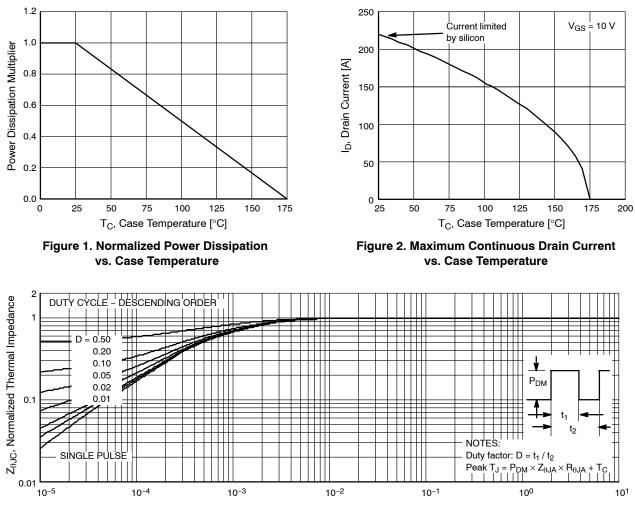
t _{on}	Turn-On Time		-	-	98	ns
t _{d(on)}	Turn-On Delay		-	30	-	ns
tr	Rise Time		-	34	-	ns
t _{d(off)}	Turn-Off Delay		-	40	-	ns
t _f	Fall Time		-	17	-	ns
t _{off}	Turn-Off Time		-	-	86	ns

DRAIN-SOURCE DIODE CHARACTERISTIC

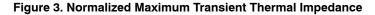
V_{SD}	Source-to-Drain Diode Voltage	I_{SD} = 80 A, V_{GS} = 0 V	-	-	1.25	V
		I_{SD} = 40 A, V_{GS} = 0 V	-	-	1.2	V
t _{rr}	Reverse-Recovery Time	$I_{F} = 80 \text{ A}, \text{ dI}_{SD}/\text{dt} = 100 \text{ A}/\mu\text{s},$	-	80	120	ns
Q _{rr}	Reverse-Recovery Charge	V _{DD} = 64 V	-	95	140	nC

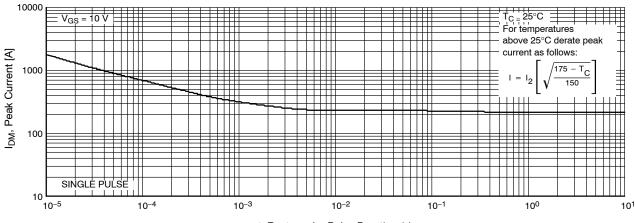
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production.

TYPICAL CHARACTERISTICS



t, Rectangular Pulse Duration (s)





t, Rectangular Pulse Duration (s)

Figure 4. Peak Current Capability

TYPICAL CHARACTERISTICS (continued)

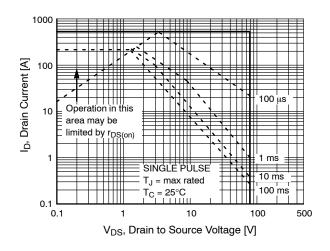
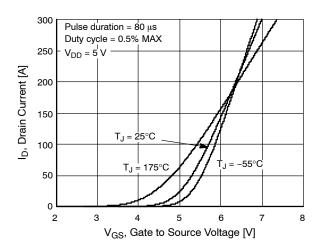


Figure 5. Forward Bias Safe Operating Area





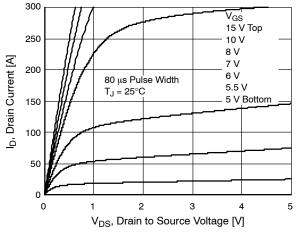
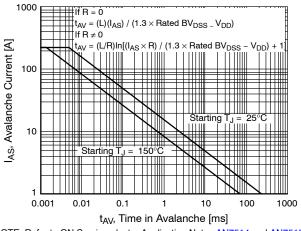


Figure 9. Saturation Characteristics



NOTE: Refer to ON Semiconductor Application Notes AN7514 and AN7515.

Figure 6. Unclamped Inductive Switching Capability

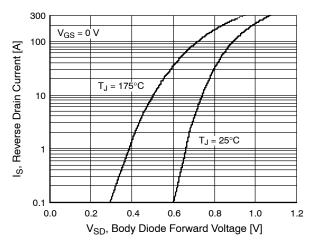


Figure 8. Forward Diode Characteristics

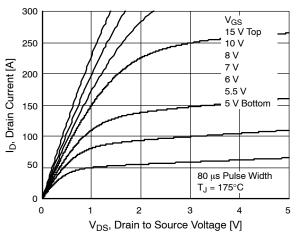
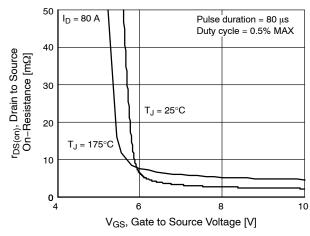
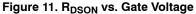
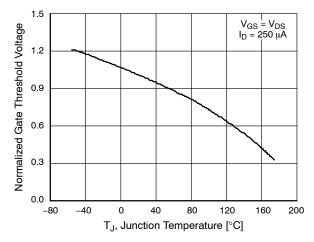


Figure 10. Saturation Characteristics

TYPICAL CHARACTERISTICS (continued)









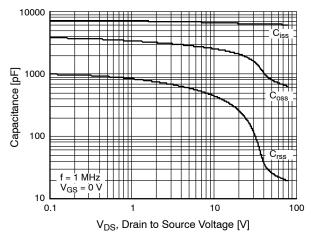


Figure 15. Capacitance vs. Drain to Source Voltage

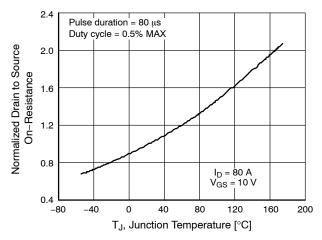


Figure 12. Normalized R_{DSON} vs. Junction Temperature

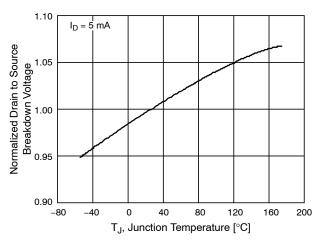


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

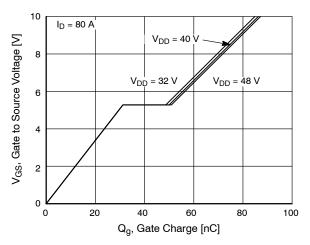
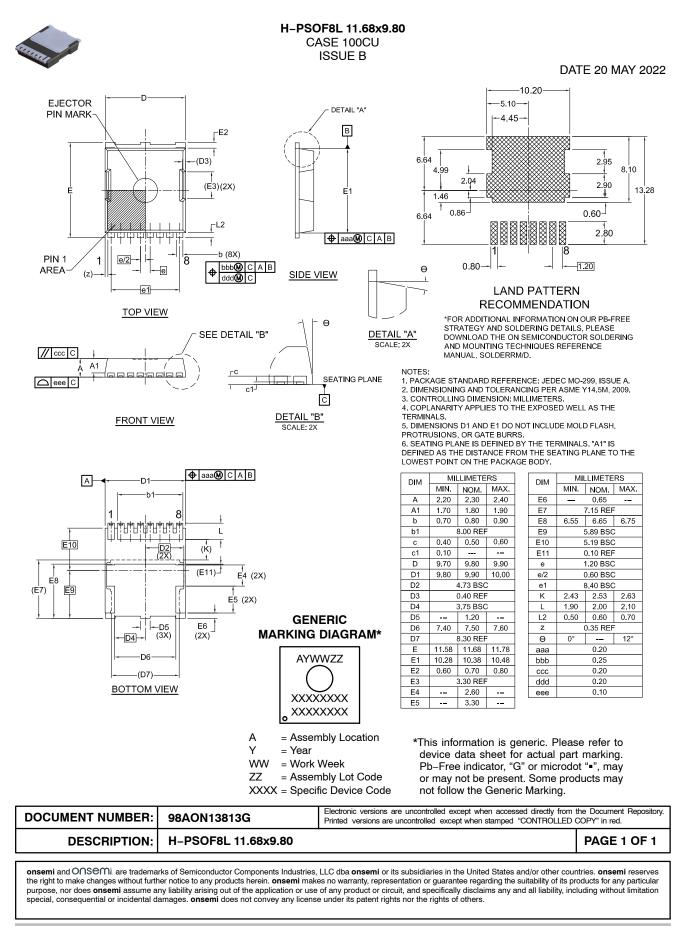


Figure 16. Gate Charge vs. Gate to Source Voltage

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